

Title (en)

METHOD OF FILLING AND/OR SEALING THE GAPS, HOLES OR INTERSTICES ON PRINTING PLATES ATTACHED TO FORM CYLINDERS

Publication

**EP 0406585 A3 19910731 (DE)**

Application

**EP 90110994 A 19900611**

Priority

DE 3920093 A 19890620

Abstract (en)

[origin: EP0406585A2] The invention relates to a method for filling and/or sealing gaps, cavities or interstices which are formed when printing plates which are resistant to alcoholic printing ink solvents are attached to a plate cylinder, by means of a photocurable sealing or filling compound of at least one photopolymerisable, ethylenically unsaturated low molecular weight compound (a), at least one polymeric binder (b) which is compatible with the photopolymerisable low molecular weight compounds of component (a), at least one photopolymerisation initiator (c) and conventional auxiliaries and additives (d). After it has been applied, this sealing or filling compound is cured by exposure to light and can be machined.

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CPC (source: EP)

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Citation (search report)

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